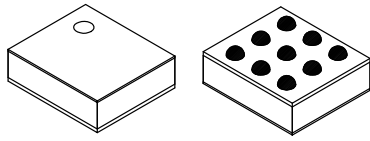


MECHANICAL CASE OUTLINE

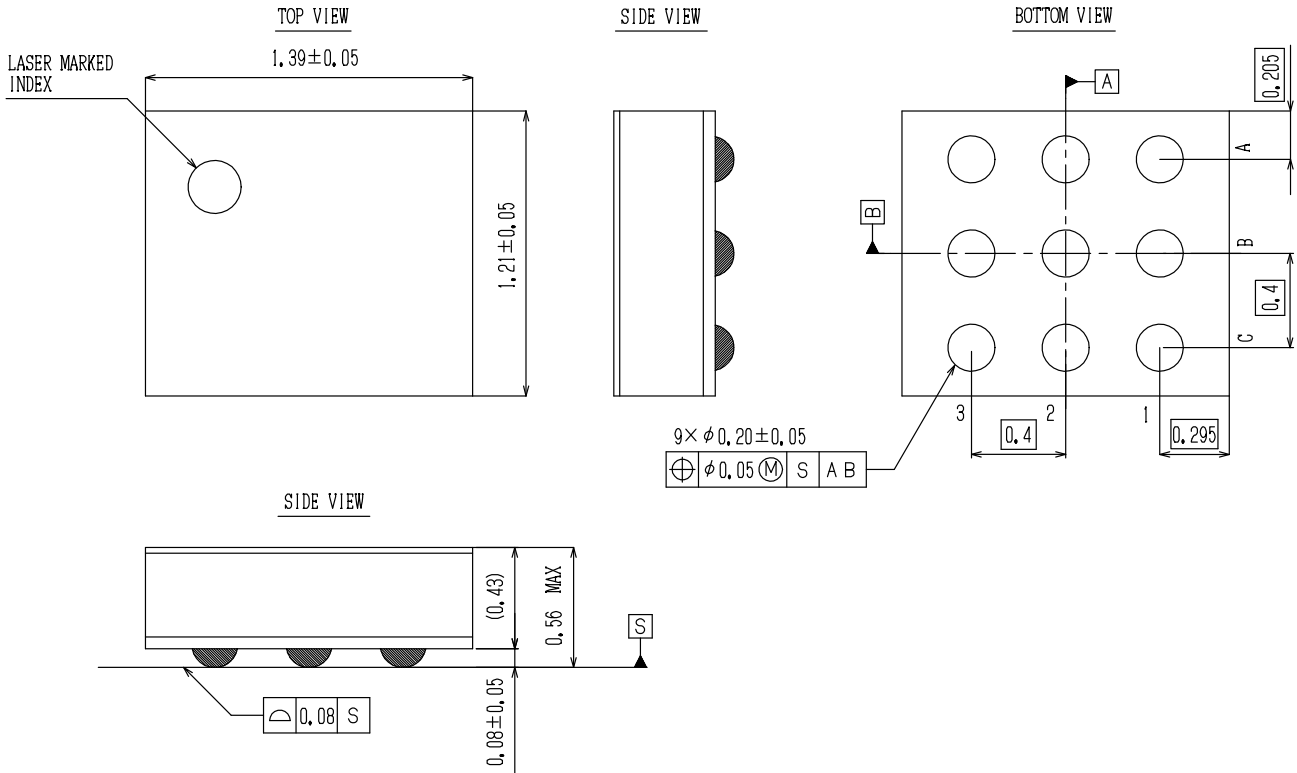
PACKAGE DIMENSIONS

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WLCSP9 1.39x1.21 / WLP9
CASE 567DQ
ISSUE 0

DATE 31 MAR 2012



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